

## **FMD7N60P5**

# **N-CHANNEL POWER MOSFET**

#### Features:

- Fast body diode eliminates the need for external diode in ZVS applications.
- Lower gate charge results in simpler drive requirements
- Higher gate voltage threshold offers improved noise immunity
- Low on-resistance
- RoHS compliant

### **Applications:**

- Motor control
- Uninterruptible power supplies
- Zero voltage switching SMPS

| $V_{DSS}$       | 600 | V  |
|-----------------|-----|----|
| $I_D$           | 7   | A  |
| Trr             | 198 | ns |
| $R_{DS(ON)Typ}$ | 1.1 | Ω  |



#### **Absolute** (Tc= $25^{\circ}$ C):

| Symbol             | Parameter  | Rating     |      |  |  |
|--------------------|--|------------|------|--|--|
| $V_{\mathrm{DSS}}$ | Drain-to-Source Voltage                          | 600        | V    |  |  |
| T                  | Continuous Drain Current                         | 7*         | A    |  |  |
| $I_{\rm D}$        | Continuous Drain Current T <sub>C</sub> = 100 °C | 4.8*       | A    |  |  |
| $I_{DM}$           | Pulsed Drain Current                             | 28*        | A    |  |  |
| $V_{GS}$           | Gate-to-Source Voltage                           | ±30        | V    |  |  |
| E <sub>AS</sub> 2  | Single Pulse Avalanche Energy                    | 440        | mJ   |  |  |
| E <sub>AR</sub> ①  | Avalanche Energy, Repetitive                     | 50         | mJ   |  |  |
| I <sub>AR</sub> ①  | Avalanche Current                                | 3.3        | A    |  |  |
| $P_D$              | Power Dissipation                                | 40         | W    |  |  |
| dv/dt              | Peak Diode Recovery dv/dt                        | 5          | V/nS |  |  |
| $T_{J}$            | Junction Temperature                             | 150        | °C   |  |  |
| $T_{stg}$          | Storage Temperature Range                        | -55 to 150 | °C   |  |  |

<sup>\*:</sup> Drain current limited by maximum junction temperature

### **Ordering Information**

| Product number | Package | Marking   | Packing     | Quantity |
|----------------|---------|-----------|-------------|----------|
| FMD7N60P5      | TO252   | FMD7N60P5 | Tape & Reel | 2500     |

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#### **Electronic Characteristics (Tc=25°C)**

| PARAMETER                                    | SYMBOL                      | TEST CONDITION MIN   |     | TYP  | MAX  | UNIT |  |
|--|-----------------------------|--|-----|------|------|------|--|
| Drain-source Breakdown Voltage               | BV <sub>DSS</sub>           | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                 | 600 |      |      | V    |  |
| Breakdown Voltage Temperature<br>Coefficient | ΔBV <sub>DSS/</sub> Δ<br>Tj | I <sub>D</sub> =250uA, Referenced to 25°C                                  |     | 0.6  |      | V/°C |  |
| Gate Threshold Voltage                       | $V_{\text{GS(TH)}}$         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA                   | 2.0 |      | 4.0  | ٧    |  |
| Drain course Leakage Current                 |                             | V <sub>DS</sub> =600V,V <sub>GS</sub> =0V, Tj=25°C                         |     |      | 1    | μΑ   |  |
| Drain-source Leakage Current                 | I <sub>DSS</sub>            | V <sub>DS</sub> =480V,V <sub>GS</sub> =0V, Tj=125°C                        |     |      | 100  | μΑ   |  |
| Forward Transconductance                     | gfs                         | V <sub>DS</sub> =15V, I <sub>D</sub> =3.5A <b>③</b>                        |     | 7    |      | S    |  |
| Gate-body Leakage Current                    | I <sub>GSS</sub>            | V <sub>DS</sub> =0V,V <sub>GS</sub> =±30V                                  |     |      | ±100 | nA   |  |
| Drain-source On Resistance                   | R <sub>DS(ON)</sub>         | V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A <b>③</b>                        |     | 1.1  | 1.5  | Ω    |  |
| Input Capacitance                            | Ciss                        |  |     | 1050 |      | pF   |  |
| Output Capacitance                           | Coss                        | V <sub>G</sub> s = 0V, V <sub>D</sub> s = 25V<br>F = 1.0MHZ                |     | 84   |      |      |  |
| Reverse transfer Capacitance                 | Crss                        |  |     | 12   |      |      |  |
| Turn-on Delay Time                           | Td(on)                      |  |     | 17   |      |      |  |
| Rise Time                                    | Tr                          | V <sub>DD</sub> =300V, I <sub>D</sub> =7.0A                                |     | 20   |      | ns   |  |
| Turn -Off Delay Time                         | Td(off)                     | R <sub>G</sub> =25Ω <b>③</b>   |     | 39   |      |      |  |
| Fall Time                                    | Tf                          |  |     | 18   |      | 1    |  |
| Total Gate Charge                            | Qg                          |  |     | 21   |      | nC   |  |
| Gate-to-Source Charge                        | Qgs                         | I <sub>D</sub> =7.0A, V <sub>DS</sub> = 480V<br>V <sub>GS</sub> = 10V<br>③ |     | 4.8  |      | nC   |  |
| Gate-to-Drain Charge                         | Qgd                         | •  |     | 6.5  |      | nC   |  |
| Continuous Diode Forward<br>Current          | Is                          |  |     |      | 7.0  | А    |  |
| Max Pulsed Diode Forward<br>Current          | I <sub>SM</sub>             |  |     |      | 28   | А    |  |
| Diode Forward Voltage                        | V <sub>SD</sub>             | Tj=25°C, Is=7.0A,V <sub>GS</sub> =0V <b>3</b>                              |     |      | 1.4  | V    |  |
| Reverse Recovery Time                        | trr                         | Tj=25°C, If=7.0A   |     | 198  |      | ns   |  |
| Reverse Recovery Charge                      | Qrr                         | di/dt=100A/μs<br>③   |     | 0.5  |      | uC   |  |
| Thermal Resistance Junction-case             | Rth <sub>JC</sub>           |  |     | 3.13 |      | °C/W |  |
| Thermal Resistance Junction-ambient          | Rth <sub>JA</sub>           |  |     | 62.5 |      | °C/W |  |

#### Notes:

- ① Repetitive rating: Pulse width limited by maximum junction temperature
- ② Starting Tj=25°C,  $V_{DD}$  =50V, L=18mH,  $R_G$  =25 $\Omega$ ,  $I_{AS}$ =7.0A
- ③ Pulse Test : Pulse width  $\leq 300 \mu s$ , Duty cycle  $\leq 2\%$



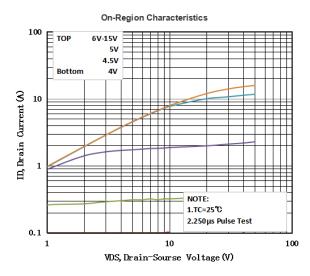


Fig.1 Typical Output Characteristics, Tc=25 ℃

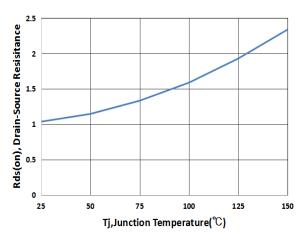


Fig.3 On-Resistance vs. Temperature

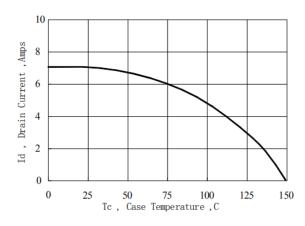


Fig.5 Maximum Drain Current vs.Case Temperature

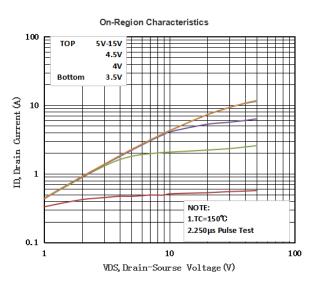


Fig.2 Typical Output Characteristics, Tc=150°C

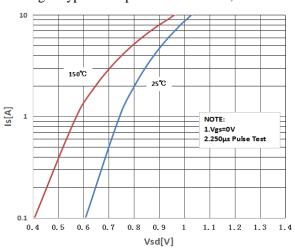


Fig.4 Typical Source-Drain Diode Forward Voltage

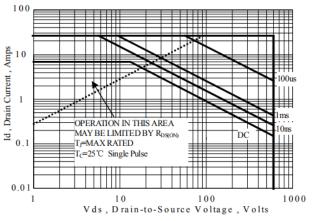


Fig.6 Maximum Safe Operating Area



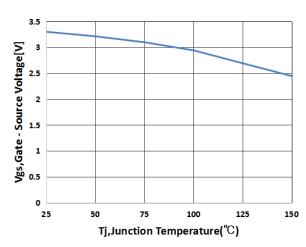


Fig.7 Gate Threshold Voltage vs. Temperature

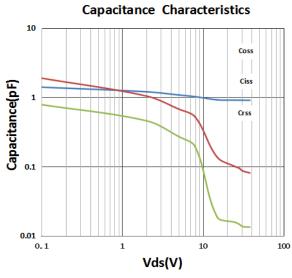


Fig.9 Capacitance Characteristics

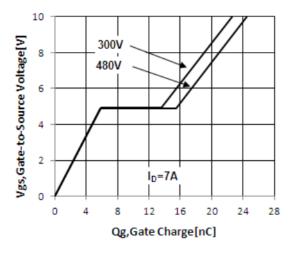


Fig.11 Gate Charge vs. Gate to Source Voltage

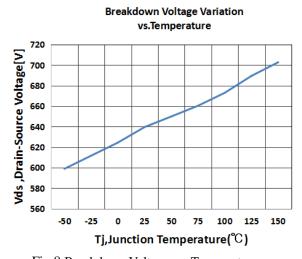


Fig.8 Breakdown Voltage vs. Temperature

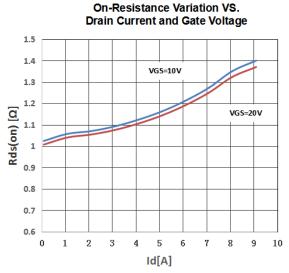


Fig. 10 On-Resistance vs. Drain Current & Gate Voltage



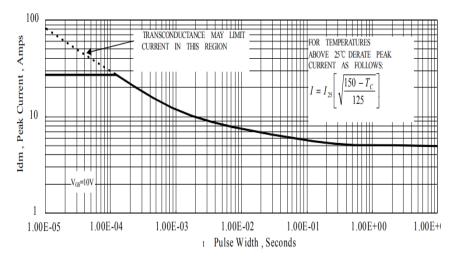


Fig.12 I<sub>DM</sub> vs. Pulse Width

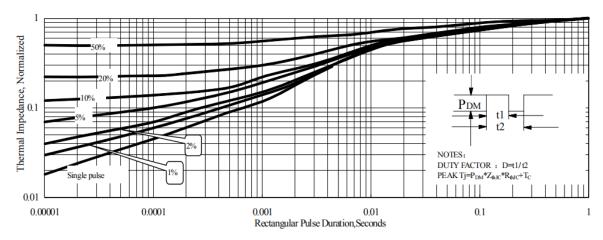


Fig.13 Normalized Thermal Impendence vs. Rectangular Pulse Duration

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# **TO-220FP MECHANICAL DATA**

UNIT: mm

| SYMBOL         | min   | nom | max   | SYMBOL         | min   | nom  | max   |
|----------------|-------|-----|-------|----------------|-------|------|-------|
| Α              | 4.40  |     | 4.95  | е              |       | 2.54 |       |
| A <sub>1</sub> | 2.30  |     | 2.90  | L              | 12.50 |      | 14.30 |
| b              | 0.45  |     | 0.90  | L <sub>1</sub> | 9.10  |      | 10.05 |
| b <sub>1</sub> | 1.10  |     | 1.70  | L <sub>2</sub> | 15.00 |      | 16.00 |
| С              | 0.35  |     | 0.90  | L <sub>3</sub> | 3.00  |      | 4.00  |
| D              | 14.50 |     | 17.00 | øр             | 3.00  |      | 3.50  |
| D1             | 6.10  |     | 9.00  | Q              | 2.30  |      | 2.80  |
| Е              | 9.60  |     | 10.30 |                |       |      |       |

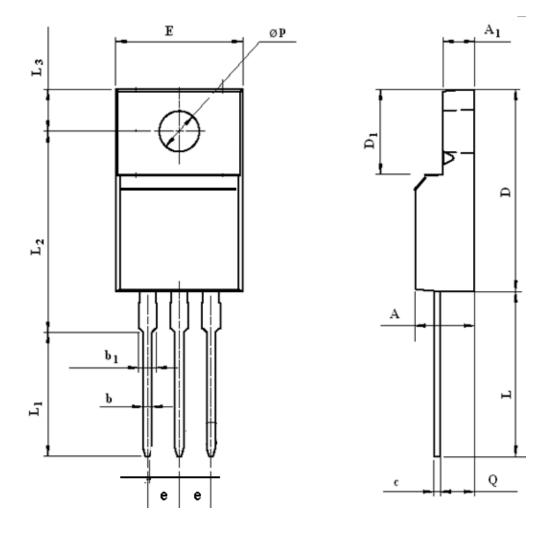


Fig.14 Dimension of Package

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